

TOSHIBA Transistor Silicon NPN Epitaxial Type (PCT Process)

TPCP8505

High-Speed Switching Applications DC-DC Converter Applications

- High DC current gain: $h_{FE} = 400$ to 1000 (IC = 0.3 A)
- Low collector-emitter saturation: V_{CE} (sat) = 0.14 V (max)
- High-speed switching: tf = 120 ns (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Character	istic	Symbol	Rating	Unit	
Collector-base voltage		V _{CBO}	100	V	
Collector-emitter voltage		V _{CEX}	80	V	
		V _{CEO}	50		
Emitter-base voltage		V _{EBO}	7	V	
Collector current	DC (Note 1)	IC	3.0	Α	
	Pulse (Note 1)	ICP	5.0	(P^=	
Base current		lΒ	0.3	А	
Collector power	t = 10s	P _C (Note 2)	3.0	W	
dissipation (t = 10 s)	DC	PC (Note 2)	1.25		
Junction temperature		Tj	150	°C	
Storage temperature range		T _{stg}	-55 to 150	°C	

Unit: mm B 0.05(M) B A 0.8±0.05 $0.28^{+0.1}_{-0.11}$ $1.12^{+0.13}_{-0.12}$ $1.12^{+0.13}_{-0.12}$ $0.28^{+0.1}_{-0.11}$ 1.Collector 5.Emitter 6.Collector 2 Collector 7.Collector 3.Collector 8.Collector 4.Base **JEDEC JEITA** TOSHIBA 2-3V1A

Weight: 0.017 g (typ.)

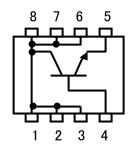
- Note 1: Ensure that the junction temperature does not exceed 150°C during use of this device.
- Note 2: Mounted on an FR4 board (glass epoxy, 1.6 mm thick, Cu area: 645 mm²)
- Note 3: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

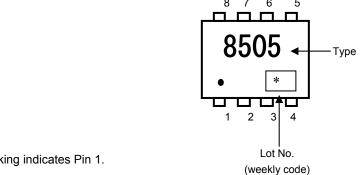
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



Figure 1. Circuit Configuration (top view)

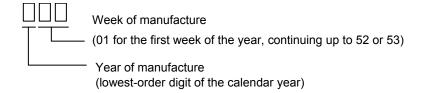
Figure 2. Marking (Note 4)





Note 4: • on the lower left of the marking indicates Pin 1.

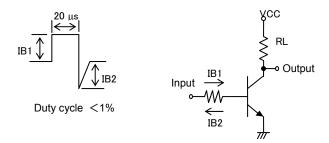
* Weekly code (three digits):

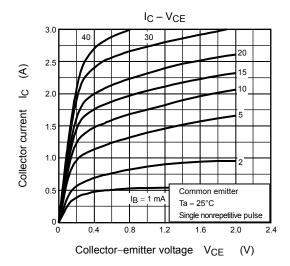


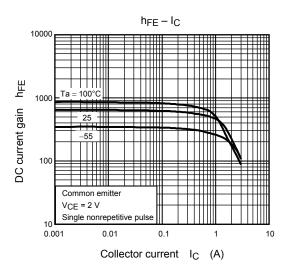
Electrical Characteristics (Ta = 25°C)

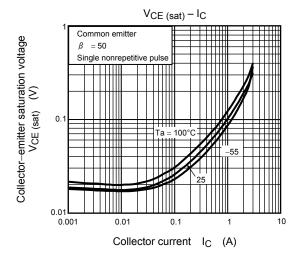
Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current		I _{CBO}	$V_{CB} = 100 \text{ V}, I_{E} = 0$	_	_	100	nA
Emitter cut-off current		I _{EBO}	V _{EB} = 7 V, I _C = 0	_	_	100	nA
Collector-base breakdown voltage		V (BR) CBO	$I_C = 1 \text{ mA}, I_B = 0$	100	_		٧
Collector-emitter breakdown voltage		V (BR) CEO	$I_C = 10 \text{ mA}, I_B = 0$	50	_	_	V
DC current gain		h _{FE} (1)	$V_{CE} = 2 \text{ V}, I_{C} = 0.3 \text{ A}$	400	_	1000	
		h _{FE} (2)	V _{CE} = 2 V, I _C = 1.0 A	200	_	_	
Collector-emitter saturation voltage		V _{CE} (sat)	I _C = 1 A, I _B = 20 mA	_	_	0.14	V
Base-emitter saturation voltage		V _{BE} (sat)	I _C = 1 A, I _B = 20 mA	_	_	1.1	V
Switching time	Rise time	t _r	See Figure 3 circuit diagram $V_{CC} \simeq 30 \text{ V, RL} = 30 \Omega$	_	40	_	
	Storage time	t _{stg}		_	500	_	ns
	Fall time	t _f	$I_{B1} = -I_{B2} = 33 \text{ mA}$	_	120	_	

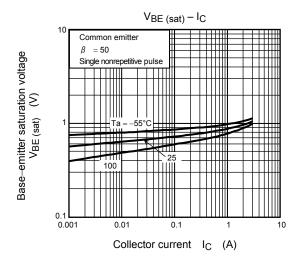
Figure 3. Switching Time Test Circuit & Timing Chart

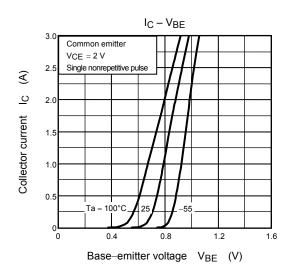




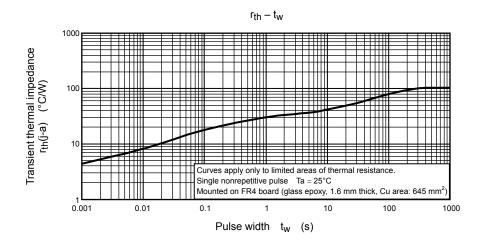


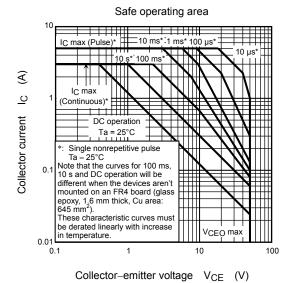






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